

# SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

# 2SD1620 - NPN Epitaxial Planar Silicon Transistor 1.5V, 3V Strobe Applications

### **Features**

- Less power dissipation because of low VCE(sat), permitting more flashes of light to be emitted.
- Large current capacity and highly resistant to breakdown.
- Excellent linearity of hFE in the region from low current to high current.
- · Ultrasmall size supports high-density, ultrasmall-sized hybrid IC designs.

# **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		30	V
Collector-to-Emitter Voltage	VCEX		20	V
Collector-to-Emitter Voltage	VCEO		10	V
Emitter-to-Base Voltage	VEBO		6	V
Collector Current	IC		3	А
Collector Current (Pulse)	ICP		5	А
Collector Dissipation	PC		500	mW
		Mounted on a ceramic board (250mm <sup>2</sup> ×0.8mm)	1.3	W
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

#### Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
	Symbol		min	typ	max	Unit
Collector Cutoff Current	ICBO	V <sub>CB</sub> =20V, I <sub>E</sub> =0A			100	nA
Emitter Cutoff Current	IEBO	VEB=4V, IC=0A			100	nA
DC Current Gain	hFE	VCE=2V, IC=3A	140	210		
Gain-Bandwidth Product	fΤ	V <sub>CE</sub> =10V, I <sub>C</sub> =50mA		200		MHz
Output Capacitance	Cob	V <sub>CB</sub> =10V, f=1MHz		30		pF

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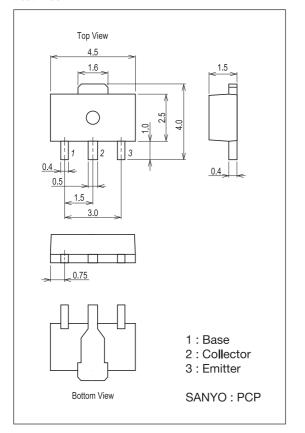
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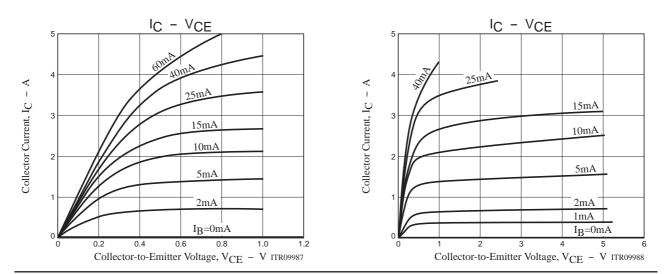
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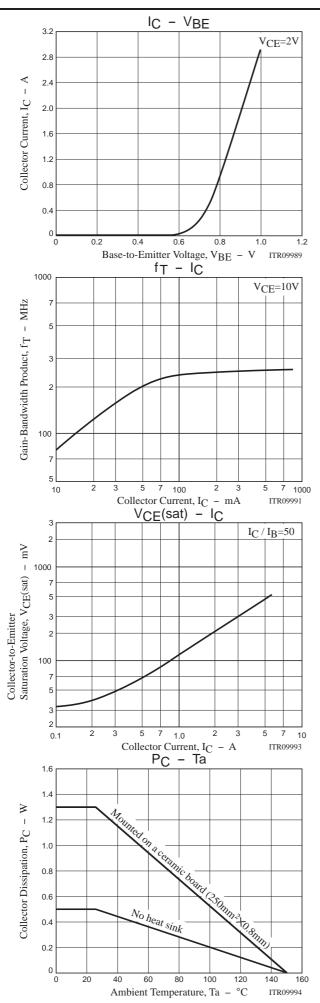
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Collector-to-Emitter Saturation Voltage	VCE(sat)	IC=3A, IB=60mA		0.3	0.4	V
Collector-to-Base Breakdown Voltage	V(BR)CBO	IC=10μA, IE=0A	30			V
Collector-to-Emitter Breakdown Voltage	V(BR)CEX	IC=1mA, VBE=3V	20			V
Collector-to-Emitter Breakdown Voltage	V(BR)CEO	IC=1mA, RBE=∞	10			V
Emitter-to-Base Breakdown Voltage	V(BR)EBO	I <sub>E</sub> =10μA, I <sub>C</sub> =0A	6			V

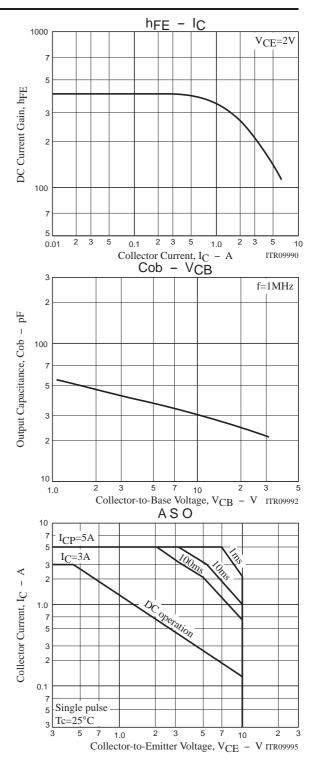
## **Package Dimensions**

unit : mm (typ) 7007B-004









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